

Overview

KEMET's 900 series encapsulated radial leaded ceramic disc capacitors are specifically designed for interferencesuppression AC line filtering applications. Having internationally recognized safety certifications, these capacitors are well-suited for applications that require keeping potentially disruptive or damaging line transients and EMI out of susceptible equipment. They are also an ideal solution when needing to suppress line disturbances at the source.

Safety Certified Capacitors are classified as either X and/ or Y capacitors. Class X capacitors are primarily used in line-to line (across-the-line) applications. In this application there is no danger of electric shock to humans should the capacitor fail, but could result in a risk of fire. The class Y capacitor is primarily used in line-to-ground (line by-pass) applications. In this application, failure of the capacitor could lead to danger of electric shock.

With a working voltage of 400 VAC in line-to-line (Class X) and 400 VAC in line-to-ground (Class Y) applications, these safety capacitors meet the impulse test criteria outlined in IEC Standard 60384. Meeting subclass X1 and Y1 requirements, these devices are certified to withstand impulses up to 4 KV (X1) and 8 KV (Y1) respectively. These encapsulated devices also meet the flame test requirements outlined in UL Standard 94 V-0.

Benefits

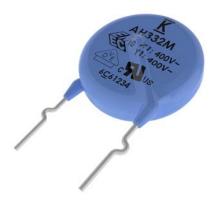
- Safety Standard Recognized (IEC 60384-14)
- Reliable operation up to 125°C
- Class X1/Y1
- 10 mm lead spacing
- · Lead (Pb)-free and RoHS Compliant
- Halogen free
- Capacitance offerings ranging from 15 4,700 pF
- Available capacitance tolerances of ±5%, ±10%, and ±20%
- High reliability
- Preformed (crimped) or straight lead configurations
- Non-polar device, minimizing installation concerns
- · 100% pure matte tin-plated lead finish allowing for excellent solderability
- Encapsulation meets flammability standard UL 94 V-0

Applications

Typical applications include:

- Line-to-line (Class X) filtering
- · Line-to-ground (Class Y) filtering
- Antenna coupling
- Primary and secondary coupling (switching power supplies)
- · Line disturbances suppression (motors and motor controls, relays, switching power supplies, and inverters)

Built Into Tomorrow





Ordering Information

C9	3	1	U	101	J	V	S	D	Α	A	7317
Ceramic Series	Body Diameter	Lead Spacing ¹	Spec.	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage	Dielectric/ Temp. Char.		Lead Config. ²	Failure Rate	Packaging (C-Spec)
C9 = Ceramic 900 Series	0 = 7.0 mm 1 = 8.0 mm 2 = 9.0 mm 3 = 10.0 mm 4 = 11.0 mm 5 = 12.0 mm 6 = 13.0 mm 7 = 14.0 mm	1 = 10.0 mm	U = Safety	Two significant digits and number of zeroes	J = ±5% K = ±10% M = ±20%	V = X1 400 VAC /Y1 400 VAC	S = SL Y = Y5P W = Y5U V = Y5V	D = Disc	A = Straight B = Vertical Kink C = Outside Kink	A = N/A	See "Packaging C-Spec Ordering Options Table"

¹ "Vertical Kink" and "Outside Kink" lead configurations cannot be combined with the bulk/20 mm lead length option (WL20). 20 mm lead length is only available on capacitors ordered with straight leads (lead configuration ordering code "A"). For nonstandard lead length inquiries, please contact KEMET.

² Bulk packaging lead length availability is dependent upon "Lead Configuration." See "Dimensions" section of this document to verify availability of a specific lead length option. For nonstandard lead length inquiries, please contact KEMET.

Packaging C-Spec Ordering Options Table

Packaging Type	Lead Length (mm) ^{2,3}	Packaging Ordering Code (C-Spec)
Ammo Pack	See Note 5	7317
	3.0±1.0	WL30
	3.5±1.0	WL35
Dulk Dog	4.0±1.0	WL40
Bulk Bag	4.5±1.0	WL45
	5.0±1.0	WL50
	20.0 minimum ⁴	WL20

¹ Preformed (crimped) lead configurations include "Vertical Kink" and "Outside Kink." See "Lead Configurations" and "Ordering Information" sections of this document for further details.

² "Vertical Kink" and "Outside Kink" lead configurations cannot be combined with the bulk/20 mm lead length option (WL20). 20 mm lead length is only available on capacitors with straight leads (lead configuration ordering code "A"). For nonstandard lead length inquiries, please contact KEMET.

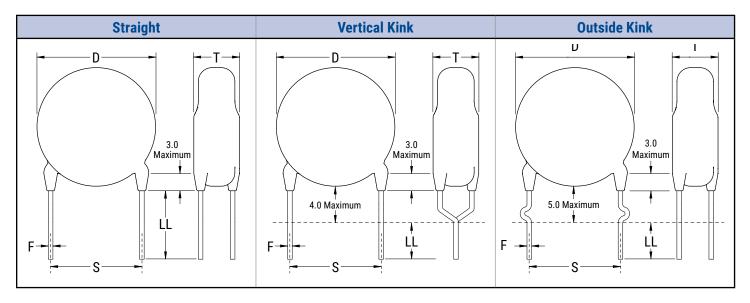
³ For nonstandard lead length inquiries, please contact KEMET.

⁴ Lead length of 20.0 mm minimum only available for straight leads.

⁵ Lead length for ammo pack packaging is defined by the H and H_0 dimensions in Table 3.



Lead Configurations



Dimensions – Millimeters

	Lead	S	Lead	D T		е	ØF
Lead Configuration	ead Configuration Load Spacing Dadu		Body Thickness	Lead Meniscus	Lead Diameter		
Straight	А	10.0	±1.0	See Table 1 - "Product Ordering Codes and Ratings"			
Vertical Kink (Preformed)	В	10.0	±1.0			3.0 maximum	0.55±0.1
Outside Kink (Preformed)	С	10.0	±1.0				

¹ Lead Configuration is identified in the 13th character of the ordering code. See "Lead Configuration" and "Ordering Information" sections of this document for further details.

² Body diameter of capacitor will limit available lead spacing and packaging options. See "Product Ordering Codes and Ratings" sections of this document for further details.



Approval Standard and Certification No.

Safety Standard	Standard No.	Subclass	Working Voltage	Certificate No.	
VDE		X1	400 VAC	40026417	
(ENEC)	IEC 60384-14	Y1 400 VAC		<u>40036417</u>	
UL	UL 60384-14 and	X1	400VAC	525(200	
CAN/CSA	E60384-14	Y1	400 VAC	<u>E356389</u>	

These devices are VDE/ENEC and UL recognized for antenna coupling and AC line-to-line (Class X) and line-to-ground (Class Y) applications per IEC60384–14 and UL 60384–14.

Environmental Compliance

These devices are Halogen-free and RoHS Compliant. They meet all requirements set forth by both EU and China RoHS directives.



General Specifications/Performance Characteristics

Dielectric/Temperature Characteristic	SL	Y5P	Y5U	Y5V		
Operating Temperature Range:		-40°C to +125	°C			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	-1,000 ~ +350 ppm/°C	-1,000 ~ +350 ppm/°C ±10% +20%/-55% ~ +30%/-				
Dielectric Withstanding Voltage [:]		4,000 VAC (60 ±5 seconds at	25°C)			
Quality Factor (Q):	30 pF and above: ≥ 1,000 Below 30 pF: ≥ 400 +(20 x C)*	Se	e "Dissipation Facto	or"		
Dissipation Factor (tanδ) at +25°C ^{1:}	See "Quality Factor" 2.50% 2.50% 5.0%			5.0%		
Insulation Resistance (IR) Limit at +25°C:	10,000 MΩ Minimum (500 VDC applied for 60 ±5 seconds at 25°C)					

*C = Nominal capacitance

¹ Capacitance and Dissipation Factor (DF) measured under the following conditions:

SL: 1 MHz ±100 kHz and 1.0 ±0.2 Vrms

X5P, Y5U, and Y5V: 1 kHz ±50 Hz and 1.0 ±0.2 Vrms

Note: When measuring capacitance, it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."



Table 1 – Product Ordering Codes and Ratings

				Dii	mensions (mm)		Lead S	pacing				
Dielectric/ Temp. Char.	KEMET Part Number	Capacitance	Capacitance Tolerance	Body Diameter (Maximum)	Body Thickness (Maximum)	Lead Diameter	Bulk Packaging	Ammo Packaging				
	C901U150JVSD(1)A(2)	15 pF										
	C901U180JVSD(1)A(2)	18 pF										
	C901U200JVSD(1)A(2)	20 pF										
	C901U220JVSD(1)A(2)	22 pF										
	C901U240JVSD(1)A(2)	24 pF		7.0								
	C901U270JVSD(1)A(2)	27 pF										
	C901U300JVSD(1)A(2)	30 pF										
	C901U330JVSD(1)A(2)	33 pF										
	C901U360JVSD(1)A(2)	36 pF	. 50		5.0	0.55.0.4						
SL	C901U390JVSD(1)A(2)	39 pF	±5%		5.0	0.55±0.1	10 mm					
	C911U470JVSD(1)A(2)	47 pF										
	C911U500JVSD(1)A(2)	50 pF										
	C911U510JVSD(1)A(2)	51 pF		8.0								
	C911U560JVSD(1)A(2)	56 pF										
	C911U620JVSD(1)A(2)	62 pF										
	C921U680JVSD(1)A(2)	68 pF		0.0								
	C921U750JVSD(1)A(2)	75 pF		9.0								
	C921U820JVSD(1)A(2)	82 pF		10.0								
	C931U101JVSD(1)A(2)	100 pF		10.0								
	C901U101KVYD(1)A(2)	100 pF				1	1					
	C901U151KVYD(1)A(2)	150 pF										
	C901U221KVYD(1)A(2)	220 pF			-	-		7.0				
	C901U331KVYD(1)A(2)	330 pF				0.55±0.1						
Y5P	C911U471KVYD(1)A(2)	470 pF	±10%	8.0	5.0		10 mm					
	C921U561KVYD(1)A(2)	560 pF										
	C921U681KVYD(1)A(2)	680 pF		9.0								
	C941U102KVYD(1)A(2)	1,000 pF		11.0								
		.,										
	C911U102MVWD(1)A(2)	1,000 pF		8.0								
	C921U152MVWD(1)A(2)	1,500 pF		9.0								
Y5U	C931U222MVWD(1)A(2)	2,200 pF	±20%	10.0	5.0	0.55±0.1	10	mm				
100	C951U332MVWD(1)A(2)	3,300 pF	12U /0	12.0	5.0	0.0010.1						
	C961U392MVWD(1)A(2)	3,900 pF		13.0								
	C971U472MVWD(1)A(2)	4,700 pF		14.0								
		1005 5			· · · · · · · · · · · · · · · · · · ·	1	1					
	C901U102MVVD(1)A(2)	1,000 pF		7.0								
VEV	C911U152MVVD(1)A(2)	1,500 pF	100%	8.0		0 55 10 1	10					
Y5V	C921U222MVVD(1)A(2)	2,200 pF	±20%	9.0	5.5	0.55±0.1	10 1	1111				
	C941U332MVVD(1)A(2)	3,300 pF		11.0								
	C951U472MVVD(1)A(2)	4,700 pF		12.0	L		l					
	KEMET Part Number	Capacitance	Capacitance Tolerance	Body Diameter (Maximum)	Body Thickness (Maximum)	Lead Diameter	Lead S	pacing				

(1) To properly complete ordering code, insert the one-digit character code to reflect the required lead configuration: (See "Lead Configuration" section of this document, page 2, for further details.)

A = Straight

B = Vertical Kink

C = Outside Kink

(2) To properly complete ordering code, enter the four-digit numeric or alphanumeric "Packaging C-Spec Ordering Code." See "Dimensions" section of this document, page 2, for available options.



Table 2 – Performance & Reliability: Test Methods and Conditions

lt	em	Speci	fication	Test Method				
Operating Ten	nperature Range			-40°C to +125°C				
	Between lead wires	No f	ailures	The capacitor shall not be damaged when 4,000 VAC (rms) is applied between the lead wires for 60 seconds.				
Dielectric Strength	Body Insulation	No failures		into a container filled with metal balls		s tightly citor n each ed 500 VAC		
Insulation R	esistance (IR)	10,000 M	Ω minimum		sistance shall be me ±5 seconds of chargi	asured with 500 ±50 VDC		
Сара	citance	Within spec	ified tolerance			5		
		Temperature Characteristics	Specification					
		Y5P, Y5U	DF ≤ 2.5%	Y5P, Y5U, and Y5V: Capacitance is measured at 1 kHz ±20% and 5 V _{rms} or less. (20 ±2°C) SL: Capacitance is measured at 1 MHz ±20% and				
Dissignation		Y5V	DF ≤ 5.0%					
	actor (DF) or Q	SL	$\ge 30 \text{ pF: } Q \ge 1,000$ < 30 pF: Q \ge 400 +(20 x C) C = Nominal capacitance	1.0 ±0.2 V _{ms} (25°C)				
				A capacitance m	easurement is made	at each step specified:		
		Temperature	Capacitance Change	Step	Temperature			
		Characteristics		1	+20±2°C			
		Y5P	Within ±10%	2	-25±2°C			
Temperature	Characteristics	Y5U	Within +22%/-56%	3	+20±2°C			
		Y5V	Within	4	+85±2°C			
			~+30%/-80%	5	+20±2°C			
		SL	-1,000 ~+350 ppm°C (+20°C ~+85°C)	Pre-treatment: Capacitor is stored at 85 ±2°C for 1 hour and then placed at roor condition ¹ for 24 ±2 hours before measurement.		our and then placed at room asurement.		
Tensile		Lead wire or capacitor body shall not break.		With the termination in its normal position, the specimen is held by its body in such a manner that the axis of the termination is vertical. A tensile force of 10 N is applied to the termination in the direction of its axis and acting in a direction away from the body of the specimen.				
Terminal Strength	Bending	•	acitor body shall not eak.	With the terminat by its body in suc vertical; a mass f the termination. a period of 2 to 3 in the vertical pla the same period	ch a manner that the orce of 5 N is then so The body of the spec seconds, through ar one and then resume of time. This operation	sition, the specimen is held axis of the termination is uspended from the end of timen is then inclined within angle of approximately 90° d to its initial position over on constitutes one bend nd in the opposite direction.		

¹ "Room Condition" is defined as follows: Temperature: 15 ~ 35°C/Humidity: 45 ~ 75%/Atmospheric Pressure: 86 ~ 106 kPa.



Table 2 – Performance & Reliability: Test Methods and Conditions cont.

lte	m	Specif	ication	Test M	/lethod		
Soldera	ability	of solder in the axia	ve a uniform coating al direction and over cumference.	The lead wire of the capacitor is dipped into molten solder for 5±0.5 seconds. The depth of immersion is up to 1.5 mm (+5/-0 mm) from the root of lead wires. Solder Temperature: Lead free solder (Sn-3Ag – 0.5 Cu) 245°C ±5°C.			
	Appearance	No visual defect		As shown in the figure below, the lead wires are immersed in molten solder up to 1.5 mm (+5/-0 mm) from the end of the epoxy meniscus (root of lead wire). Duration/Solder Temperature: 3.5 ±0.5 seconds/350°C ±10°C or			
-	IR	1,000 MΩ					
-	Dielectric Strength	Per i	tem 1	10 ±1 seconds/260°C ±5°C			
Soldering Effect (Non-Preheat)	Capacitance	Y5P, Y5U, and Y5V: Within ±10% SL: Within ±2.5% or ±0.25 pF, whichever is larger.		Screen 1.5 to 1.5 to 2.0 mm Solder Pre-treatment: Capacitor is stored at 85°C ±2°C for 1 hour and then placed at room condition ¹ for 24 ±2 hours before initial measurements. Post-treatment: Capacitor is stored for 1 to 2 hours at room condition ¹ .			
	Appearance	No visua	al defect	Capacitor is stored at 120°C +0/			
-	IR	1,00	0 ΜΩ	Then, as shown in the figure below, the lead wires are immersed in molten solder up to 1.5 mm (+5/-0mm) from the end of the epoxy meniscus (root of lead wire).			
	Dielectric Strength	Per item 1		Duration/Solder Temperature: 7.5 +0/-1 seconds/260°C ±5°C Thermal Capacitor Screen 1.5 to 2.0 mm Molten Solder Pre-treatment: Capacitor is stored at 85°C ±2°C for 1 hour and then placed at room condition ¹ for 24±2 hours before initial measurements. Post-treatment: Capacitor is stored for 1 to 2 hours at room condition ¹ .			
Soldering Effect (Preheat)	Capacitance	Y5P, Y5U, and Y5V: Within ±10% SL: Within ±2.5% or ±0.25 pF, whichever is larger.					
	Appearance	No visual defect		Steady State Humidity:	Load Humidity:		
-		Temperature Characteristics	Capacitance Change				
		Y5P	Within ±10%				
	Capacitance	Y5U	Within ±20%				
Biased Humidity		Y5V SL	Within ±30% Within ±2.5% or ±0.25 pF, whichever is larger.	90 to 95% humidity at 40°C ±2°C for 500±12 hours.	90 to 95% humidity at 40°C ±2°C for 500±12 hours with full rated voltage applied.		
-	DF	Y5P and Y5U: 5.0% maximum Y5V: 7.5% maximum		Post-treatment: Capacitor is stored for 1 to 2 hours at room condition ¹ .	Post-treatment: Capacitor is stored for 1 to 2 hours at room condition ¹ .		
-	Q	SL: Less than 30 pF: $Q \ge 100 + 10 \times C/3$ More than 30 pF: $Q \ge 200$ C = Nominal capacitance					
	IR	Y5P, Y5V and Y5U:	3,000 MΩ minimum IΩ minimum				
-	Dielectric Strength		ilures				

¹ "Room Condition" is defined as follows: Temperature: 15 ~ 35°C/Humidity: 45 ~ 75%/Atmospheric Pressure: 86 ~ 106 kPa.



Table 2 – Performance & Reliability: Test Methods and Conditions cont.

lte	em	Specification	Test Method				
Appearance Capacitance Change IR High		No visual defect Y5P, Y5V, and Y5U: Within ±20% SL: Within ±3 or ±0.3 pF, whichever is larger. 3,000 MΩ minimum SL: 1,000 MΩ minimum	Impulse Voltage: Each individual capacitor is subjected to three 8 kv impulses prior to life testing. v_{p} v_{p} v_{p} u_{p				
Fign Temperature Life	Dielectric Strength	No failures	Capacitors are placed in a circulating air oven for a period of 1,000 hours. The air in the oven is maintained at a temperature of 125°C ±2°C throughout the test. The capacitors are subjected to AC 680 V _{rms} . Each hour the voltage is increased to AC 1,000 V _{rms} for 0.1 seconds.				
		The capacitor flame extinguishes as follows:	The capacitor is exposed to a flame for 15 seconds and then removed for 15 seconds. This test is repeated for 5 cycles.				
Flame	e Test	CycleTime1 ~ 430 seconds maximum560 seconds maximum	Flame 76 Gas Burner 20° (Unit:mm)				
			The capacitors are individually wrapped in at least one, but not more than two, complete layers of cheesecloth. They are then subjected to 20 discharges. The interval between successive discharges is 5 seconds. The VAC is maintained for 2 minutes after the last discharge. $\int_{Tr} \frac{F}{C_1 + C_2 + C_3 + C_4 + C_1 + C_1 + C_2 + C_3 + C_4 + C$				
Active Flammability		The cheesecloth should not ignite.	Oscinoscope C _{1,2} 1 μ F ±10% C ₃ 0.033 μ F ±5% 10 kV L _{1.4} 1.5 Mh ±20% 16A Rod core choke Cx Test capacitor R 100 ±2% V _{AC} VR ±5% Ct 3 μ F ±5% 10 kV V _R Rated Voltage F Fuse, Rated 10A Vt Voltage applied to Ct Vx 5kV				

¹ "Room Condition" is defined as follows: Temperature: 15 ~ 35°C/Humidity: 45 ~ 75%/Atmospheric Pressure: 86 ~ 106 kPa.



Table 2 – Performance & Reliability: Test Methods and Conditions cont.

lte	em	Specif	cation		Test Met	thod	
Passive Fla	ammability	The burning time should not exceed 30 seconds. The tissue paper should not ignite. No visual defect		The capacitor under test is held into a flame and in a position which best promotes burning. Each specimen is exposed to the flame one time.		xposed to the	
	Appearance	No visua	al defect				
		Temperature Characteristics	Capacitance Change		tor is subjected to 5 tem ture Cycle	perature cycles	S.
	Capacitance	SL Y5P Y5U, Y5V	Within ±5% Within ±10% Within ±20%	Step	Temperature (°C)	Dwell Time (minutes)	Transition Time (minutes)
Temperature		SL	≥ 30 pF: Q ≥ 350	1	-40 +0/-3	30	
Cycle			< 30 pF: Q ≥ 275	2	Room temperature	3	3
			+5/2C C = Nominal	3	125 +3/-0	30	3
	DF/Q		capacitance	4	Room temperature	3	
		Y5P	DF ≤ 5%				
		Y5U, Y5V	DF ≤ 7.5%	Pre-treatm placed at r	ent: Capacitor shall be s oom condition ¹ for 24 ±2	tored at 85 ±2 hours.	for 1 hour then
	IR	3,000 MΩ SL: 1,000 M		Post-treatic condition ¹ .	ment: Capacitor is stored	for 1 to 2 hou	rs at room
	Dielectric Strength	No fa	ilures				

¹ "Room Condition" is defined as follows: Temperature: 15 ~ 35°C/Humidity: 45 ~ 75%/Atmospheric Pressure: 86 ~ 106 kPa.



Soldering and Mounting Information

Soldering:

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could reflow the solder joint between the lead and ceramic element and/or may result in thermal shocks that can crack the ceramic element.

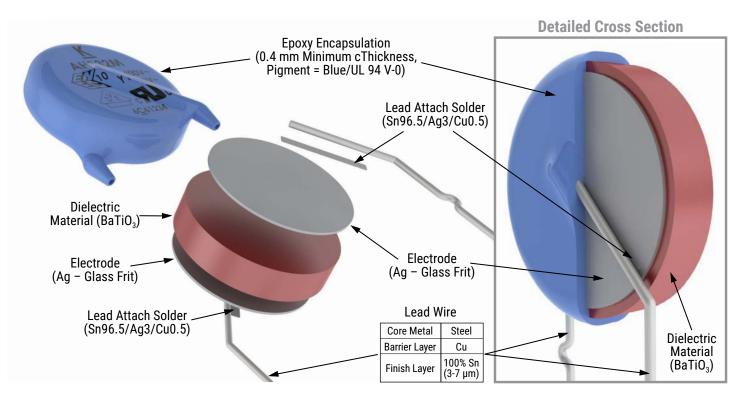
When soldering these capacitors with a soldering iron, it should be performed under the following conditions:

- Temperature of iron-tip: 400°C maximum
- Soldering iron wattage: 50 W maximum
- · Soldering time: 3.5 seconds maximum

Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions:

- · Rinse bath capacity: Output of 20 watts per liter or less
- · Rinsing time: 5 minute maximum
- Do not vibrate the PCB/PWB directly
- · Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires

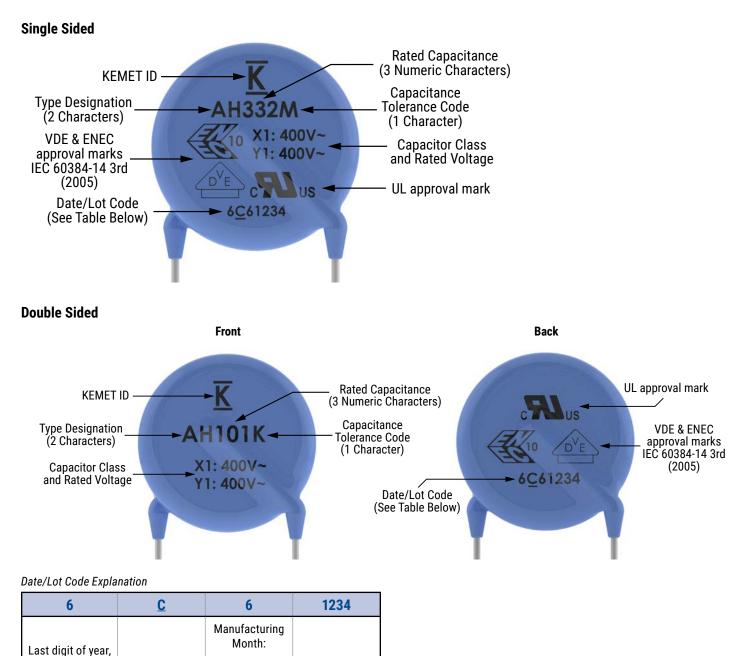


Construction



Marking

These capacitors shall be stamped or laser marked with KEMET's trademark, type designation, capacitor class, rated voltage, rated capacitance, and capacitance tolerance codes. In addition, all devices are marked with the recognized approval mark and a date/lot code for traceability. Marking will be supplied either on one side or both sides of the encapsulated capacitor body. All marking shall be legible to allow for clear identification of the component. Marking appears in legible contrast. Illustrated below is an example of the marking format and content. (Two-sided marking is limited to capacitors with body diameters ≤ 8.0 mm)



Last 4 digits of

lot number

1-9 = Jan - Sept

A = October

N = November D = December

Manufacturing

Location Code

e.g.,

6 = 2016



Packaging Quantities

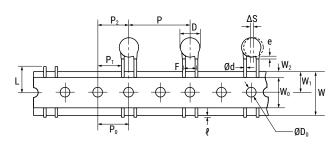
			Ammo Pack (Carrier Tape)		
Capacitor Body Diameter (mm)	Body Diameter Code ¹	Bulk Bag (Loose)	Component pitch on carrier tape ²		
			25.4 mm		
7.0	0				
8.0	1				
9.0	2		1,000 pieces/box		
10.0	3	E00 pieces /heg			
11.0	4	500 pieces/bag			
13.0	6				
14.0	7		500 pieces/box		
15.0	8				

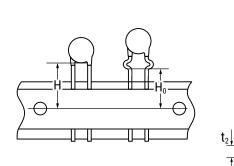
¹ The "Body Diameter Code" is located in the third character position of the ordering code. This code identifies the maximum diameter of the capacitor body in millimeters. For more information regarding the ordering code, see "Ordering Information" section of this document.

² For details regarding component pitch on carrier tape, see "Ammo Pack Taping Format" and "Ammo Pack Taping Specifications" sections of this document.



Figure 1 - Ammo Pack Taping Format (10 mm Lead Spacing)





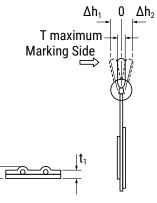


Table 3 – Ammo Pack Taping Specifications

Lead Spacing		10	mm	
Lead Style		Straight	Preformed ¹	
Item	Symbol	Dimensio	ons (mm)	
Lead Spacing	F	10.0	±1.0	
Component Pitch	Р	25.	4±2	
Sprocket Hole Pitch	P ₀	12.7	±0.3	
Sprocket Hole Center to Component Center	P ₂	12.7	′±1.5	
Sprocket Hole Center to Lead Center	P ₁	7.7±	±1.5	
Body Diameter	D	See "Product Ordering Codes and	Ratings" section of this document.	
Component Alignment (side/side)	ΔS	0±	2.0	
Carrier Tape Width	W	18.0 +1	.0/-0.5	
Sprocket Hole Position	W ₁	9.0 :	±0.5	
Height to Seating Plane ² (preformed leads ¹)	H _o	N/A	18.0 +2.0/-0	
Height to Seating Plane ² (straight leads)	Н	20.0 +1.5/-1.0	N/A	
Lead Protrusion	ę	2.0 ma	ximum	
Diameter of Sprocket Hole	D ₀	4.05	±0.2	
Lead Diameter	φd	0.55	±0.1	
Carrier Tape Thickness	t ₁	0.65	±0.3	
Total Thickness (Carrier Tape, Hold-Down Tape and Lead)	t ₂	1.5 ma	ximum	
Component Alignment (front/back)	Δh ₁	2.0 ma	ximum	
	Δh ₂	2.0 ma	ximum	
Cut Out Length	L	11.0 ma	aximum	
Hold-Down Tape Width	W _o	8.0 minimum		
Hold-Down Tape Position	W ₂	1.5:		
Coating Extension on Leads (meniscus)	е	3.0 maximum for straight lead; not to configu		
Body Thickness	Т	See "Product Ordering Codes and	Ratings" section of this document.	

¹ Preformed (crimped) lead configurations include vertical kink and outside kink. See "Lead Configurations" and "Ordering Information" sections of this document for further details.

²Also referred to as "lead length" in this document.



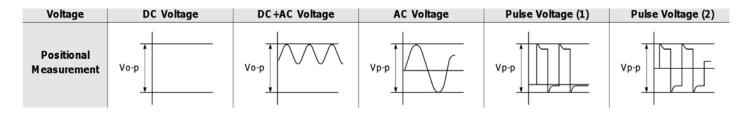
Application Notes:

Storage and Operating Conditions:

The insulating coating of these devices does not form an air and moisture-tight seal. Avoid exposure to moisture and do not use or store these devices in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt, or the like are present. Before cleaning, bonding or molding these devices, it is important to verify that your process does not affect product quality and performance. KEMET recommends testing and evaluating the performance of a cleaned, bonded or molded product prior to implementing and/or qualifying any of these processes. Store the capacitors where the temperature and relative humidity do not exceed 40 degrees Centigrade and 70% respectively. For optimum solderability, capacitor stock should be used promptly, preferably within 6 months of receipt.

Working Voltage:

Application voltage (Vp-p or Vo-p) must not exceed the voltage rating of the capacitor. Irregular voltages can be generated for a transient period of time when voltage is initially applied and/or removed from a circuit. It is important to choose a capacitor with a voltage rating greater than or equal to these irregular voltages.



Operating Temperature and Self-Generating Heat:

The surface temperature of a capacitor should be kept below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in a high-frequency current, pulse current or similar current, it may self-generate heat due to dielectric loss. Temperature rise due to self-generated heating should not exceed 20°C (while operated at an atmosphere temperature of 25°C).

Handling - Vibration and Impact:

Do not expose these devices or their leads to excessive shock or vibration during use.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRODUCT IS USED.



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Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

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